

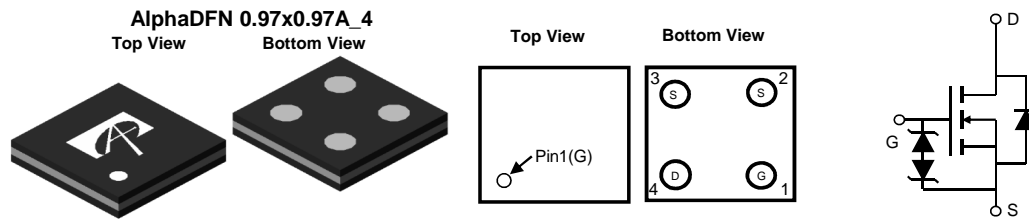
General Description

The AOC2422 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 1.2V while retaining a 5V $V_{GS(MAX)}$ rating.

Product Summary

V_{DS}	8V
I_D (at $V_{GS}=2.5V$)	3.5A
$R_{DS(ON)}$ (at $V_{GS}=2.5V$)	< 33m Ω
$R_{DS(ON)}$ (at $V_{GS}=1.8V$)	< 38m Ω
$R_{DS(ON)}$ (at $V_{GS}=1.5V$)	< 43m Ω
$R_{DS(ON)}$ (at $V_{GS}=1.2V$)	< 58m Ω

Typical ESD protection **HBM Class 2**



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	V_{DS}	8	V
Gate-Source Voltage	V_{GS}	± 5	V
Source Current (DC) ^{Note1}	I_D	3.5	A
Source Current (Pulse) ^{Note2}			
Power Dissipation ^{Note1}	P_D	0.6	W
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient ^A	$R_{\theta JA}$	110	140	$^\circ\text{C/W}$
Maximum Junction-to-Ambient ^{A D}		Steady-State	160	200

Note 1. Mounted on minimum pad PCB

Note 2. PW < 300 μs pulses, duty cycle 0.5% max

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V	8			V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =8V, V _{GS} =0V T _J =55°C			1 5	μA
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±5V			±10	μA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	0.2	0.52	0.8	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =2.5V, I _D =1.5A T _J =125°C		27 34	33 42	mΩ
		V _{GS} =1.8V, I _D =1A		30	38	
		V _{GS} =1.5V, I _D =1A		33	43	
		V _{GS} =1.2V, I _D =1A		41	58	
g _{FS}	Forward Transconductance	V _{DS} =5V, I _D =1.5A		20		S
V _{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V		0.6	1	V
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =4V, f=1MHz		870		pF
C _{oss}	Output Capacitance			250		pF
C _{riss}	Reverse Transfer Capacitance			155		pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz		2.7		KΩ
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =4.5V, V _{DS} =4V, I _D =1.5A		9.5	15	nC
Q _{gs}	Gate Source Charge			1.2		nC
Q _{gd}	Gate Drain Charge			2		nC
t _{D(on)}	Turn-On DelayTime	V _{GS} =2.5V, V _{DS} =4V, R _L =2.67Ω, R _{GEN} =3Ω		1		μs
t _r	Turn-On Rise Time			2.1		μs
t _{D(off)}	Turn-Off DelayTime			3		μs
t _f	Turn-Off Fall Time			4.2		μs
t _{rr}	Body Diode Reverse Recovery Time	I _F =1.5A, dI/dt=100A/μs		15		ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =1.5A, dI/dt=100A/μs		5		nC

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

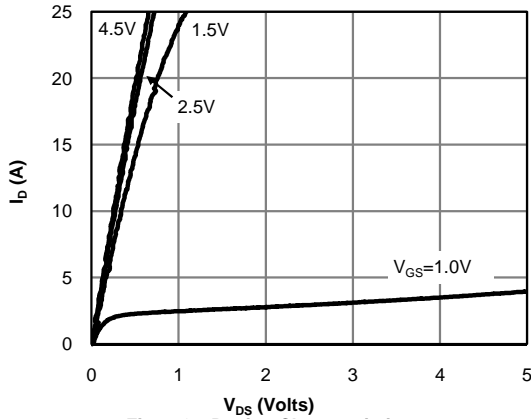


Fig 1: On-Region Characteristics

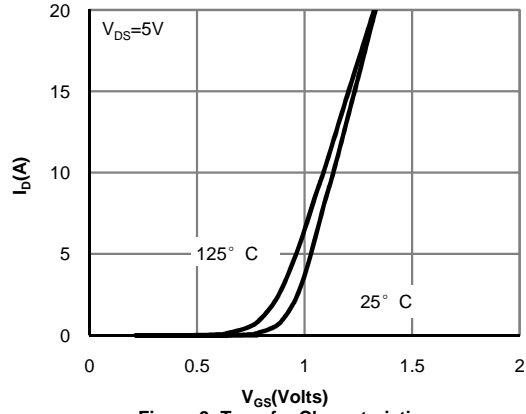


Figure 2: Transfer Characteristics

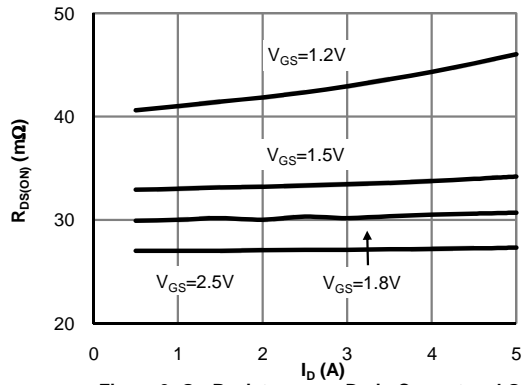


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

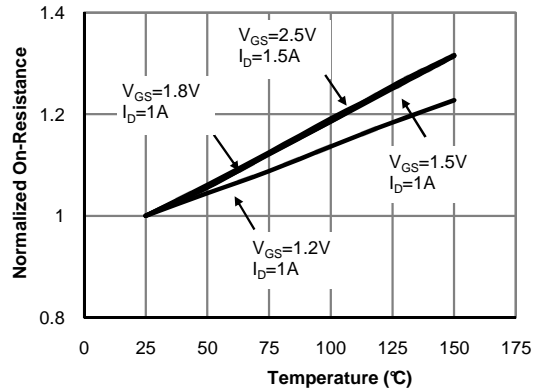


Figure 4: On-Resistance vs. Junction Temperature (Note E)

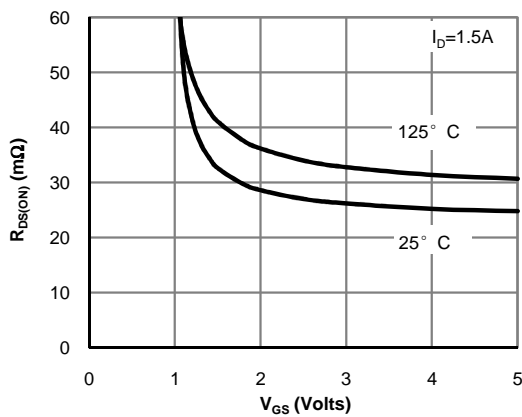


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

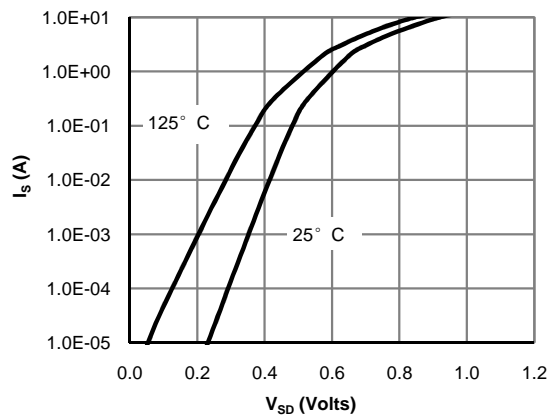


Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

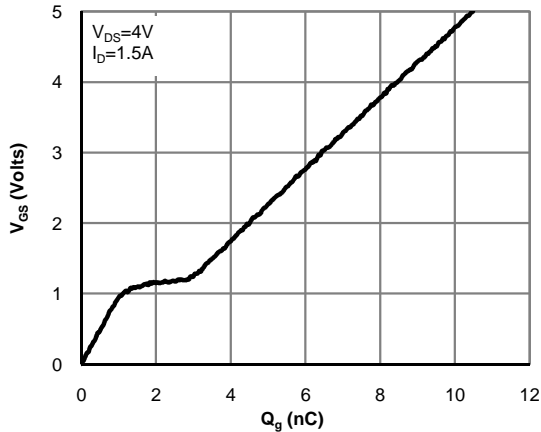


Figure 7: Gate-Charge Characteristics

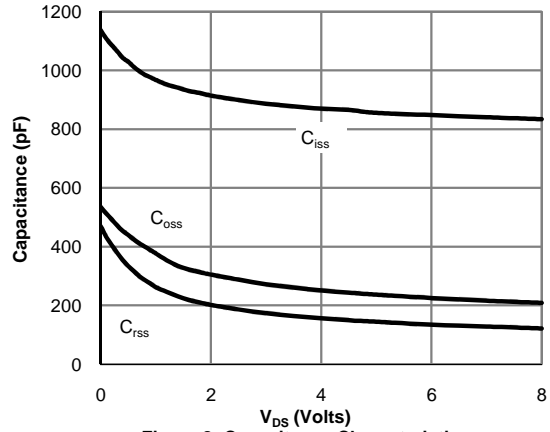


Figure 8: Capacitance Characteristics

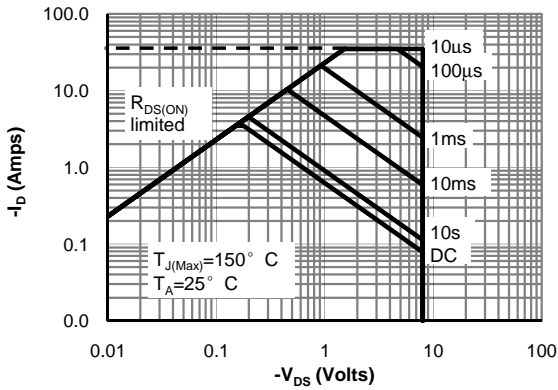


Figure 9: Maximum Forward Biased Safe Operating Area

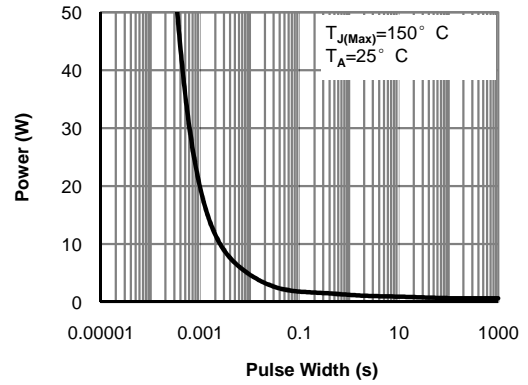


Figure 10: Single Pulse Power Rating Junction-to-Ambient

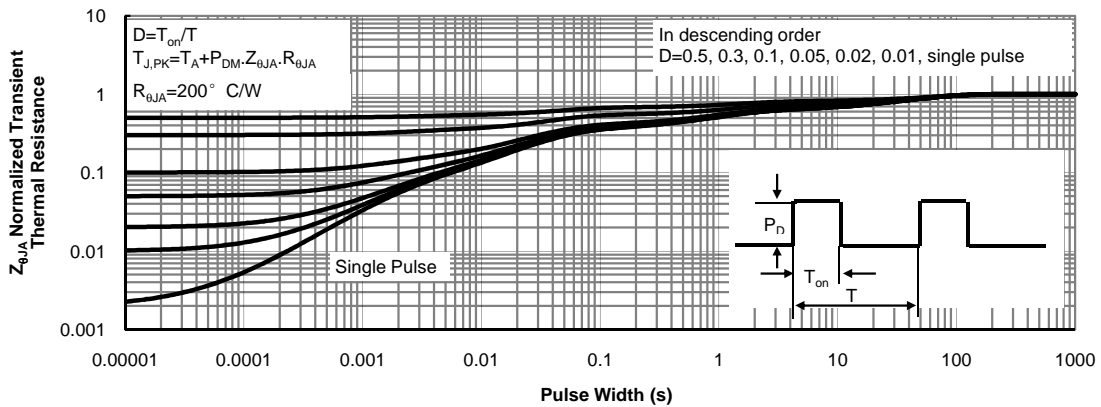
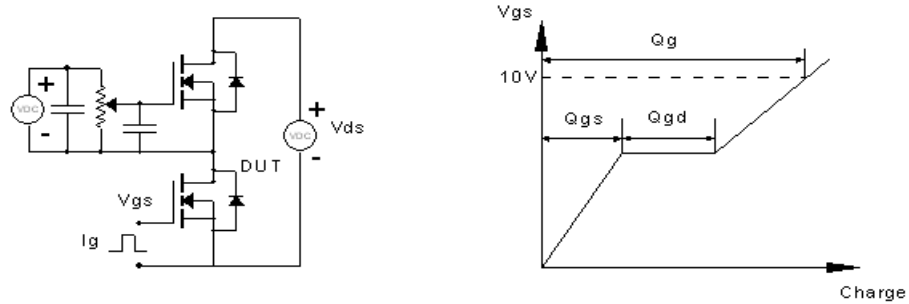
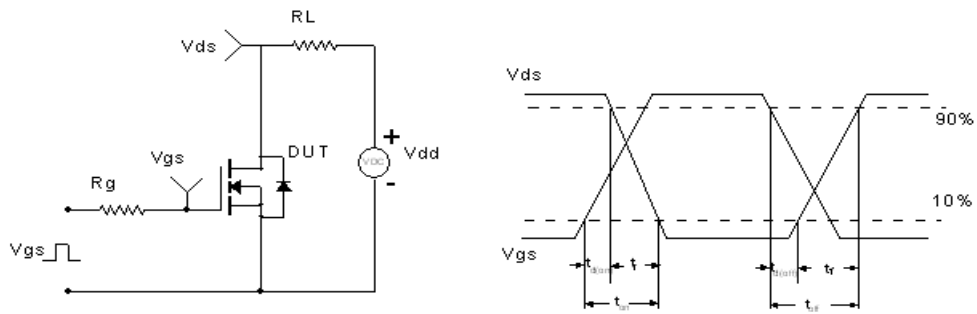


Figure 11: Normalized Maximum Transient Thermal Impedance

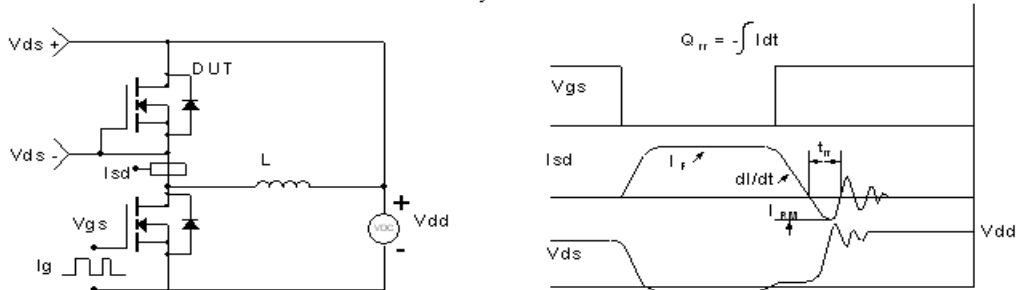
Gate Charge Test Circuit & Waveform



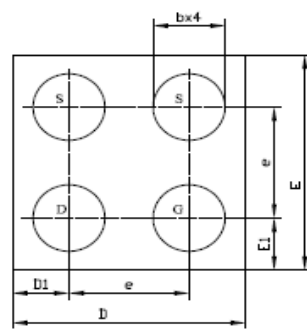
Resistive Switching Test Circuit & Waveforms



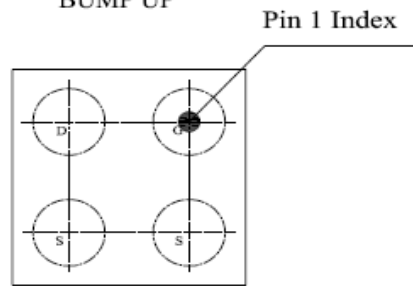
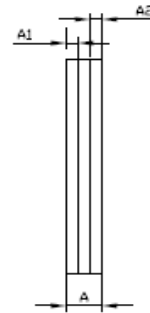
Diode Recovery Test Circuit & Waveforms



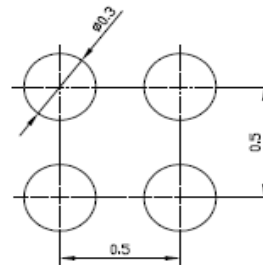
PACKAGE OUTLINE for AlphaDFN0.97x0.97A_4



BUMP UP



BUMP DOWN



RECOMMENDED LAND PATTERN

SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.28	0.30	0.36	0.011	0.012	0.014
A1	0.08	0.10	0.12	0.003	0.004	0.005
A2	0.08	0.10	0.14	0.003	0.004	0.006
b	0.20	---	0.30	0.008	---	0.012
D	0.92	0.97	1.02	0.036	0.038	0.040
D1	0.21	0.24	0.26	0.008	0.009	0.010
E	0.92	0.97	1.02	0.036	0.038	0.040
E1	0.21	0.24	0.26	0.008	0.009	0.010
e	0.500 BSC			0.0197 BSC		